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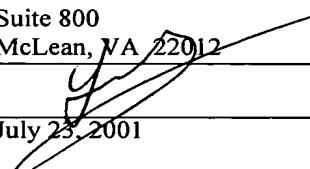
<b>TRANSMITTAL FORM</b> <i>(to be used for all correspondence after initial filing)</i>		Application Number	09/352,194
		Filing Date	July 13, 1999
		First Named Inventor	Shunpei YAMAZAKI et al.
		Group Art Unit	2823
		Examiner Name	F. TOLEDO
Total Number of Pages in This Submission		Attorney Docket Number	740756-1998

**ENCLOSURES (check all that apply)**

<input checked="" type="checkbox"/> Fee Transmittal Form <input checked="" type="checkbox"/> Fee Attached <input checked="" type="checkbox"/> Amendment / Reply <input type="checkbox"/> After Final <input type="checkbox"/> Affidavits/declaration(s) <input type="checkbox"/> Extension of Time Request <input type="checkbox"/> Express Abandonment Request <input type="checkbox"/> Information Disclosure Statement <input type="checkbox"/> Certified Copy of Priority Document(s) <input type="checkbox"/> Response to Missing Parts/ Incomplete Application <input type="checkbox"/> Response to Missing Parts under 37 CFR 1.52 or 1.53	<input type="checkbox"/> Assignment Papers <i>(for an Application)</i> <input type="checkbox"/> Drawing(s) <input type="checkbox"/> Licensing-related Papers <input type="checkbox"/> Petition <input type="checkbox"/> Petition to Convert to a Provisional Application <input type="checkbox"/> Power of Attorney, Revocation Change of Correspondence Address <input type="checkbox"/> Terminal Disclaimer <input type="checkbox"/> Request for Refund <input type="checkbox"/> CD, Number of CD(s)	<input type="checkbox"/> After Allowance Communication to Group <input type="checkbox"/> Request for Drawing Change Approval Letter
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Firm or Individual name	Luan C. Do Nixon Peabody LLP 8180 Greensboro Drive Suite 800 McLean, VA 22012
Signature	
Date	July 23, 2001

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT application of:

Shunpei YAMAZAKI et al.

Application No.: 09/352,194

) Examiner: Fernando TOLEDO

Filed: July 13, 1999

)

For: CRYSTALLINE SEMICONDUCTOR THIN FILM, METHOD OF FABRICATING THE SAME SEMICONDUCTOR DEVICE, AND METHOD OF FABRICATING THE SAME

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Ashley, Sean

**AMENDMENT**

Commissioner of Patents  
Washington, D.C. 20231

July 23, 2001

Dear Sir:

In response to the Examiner's non-Final Office Action mailed April 23, 2001, please consider the following amendments and remarks in connection with the above-identified application.

**IN THE CLAIMS:**

Please cancel claims 6-35 without prejudice or disclaimer of the subject matter contained therein.

Please amend claim 5 to read as follows:

5. (Twice Amended) A method of manufacturing a semiconductor device comprising the steps of:

forming a semiconductor film comprising silicon over a substrate;

providing said semiconductor film with a catalytic element for facilitating a crystallization of said semiconductor film;

irradiating said semiconductor film with laser light in air for crystallizing said semiconductor film after providing said catalytic element;

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